INTEGRATED CIRCUITS

DATA SHEET

CBT3257

Quad 1-of-2 multiplexer/demultiplexer

Product data Supersedes data of 27 Sep 2002





Quad 1-of-2 multiplexer/demultiplexer

CBT3257

FEATURES

- ullet 5 Ω switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114,
 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

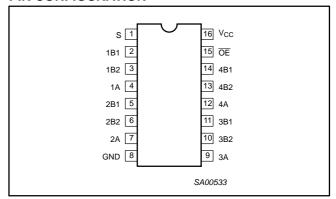
DESCRIPTION

The CBT3257 is a quad 1-of-2 high-speed TTL-compatible multiplexer/demultiplexer. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

Output Enable $(\overline{\text{OE}})$ and select-control (S) inputs select the appropriate B1 and B2 outputs for the A-input data.

The CBT3257 is characterized for operation from -40 to +85 °C.

PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	S	Select-control input
2, 3, 5, 6, 10, 11, 13, 14	1B1, 1B2, 2B1, 2B2 3B1, 3B2 4B1, 4B2	B outputs
4, 7, 9, 12	1A, 2A, 3A, 4A	A inputs
8	GND	Ground (0 V)
15	ŌĒ	Output enable
16	V _{CC}	Positive supply voltage

ORDERING INFORMATION

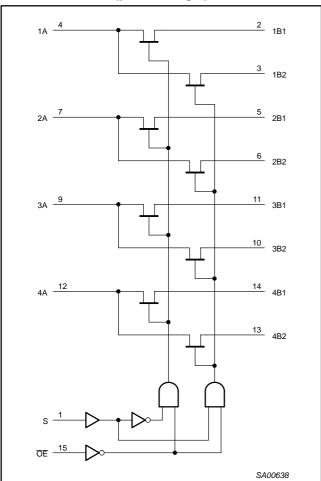
PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DWG NUMBER
16-pin plastic SO	-40 to 85 °C	CBT3257D	CBT3257D	SOT109-1
16-pin plastic SSOP	-40 to 85 °C	CBT3257DB	CT3257	SOT338-1
16-pin plastic SSOP (QSOP)	-40 to 85 °C	CBT3257DS	CBT3257	SOT519-1
16-pin plastic TSSOP	-40 to 85 °C	CBT3257PW	CBT3257	SOT403-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

Quad 1-of-2 multiplexer/demultiplexer

CBT3257

LOGIC DIAGRAM (positive logic)



FUNCTION TABLE

INP	UTS	FUNCTION
ŌĒ	S	FONCTION
L	L	A port = B1 port
L	Н	A port = B2 port
Н	Х	Disconnect

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CBT3257

ABSOLUTE MAXIMUM RATINGS1

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
VI	DC input voltage ²		-0.5 to +7.0	V
	Continuous channel current		128	mA
I _K	Input clamp current	V _{I/O} < 0	-50	mA
T _{stg}	Storage temperature range		-65 to +150	°C

NOTES

RECOMMENDED OPERATING CONDITIONS

CVMPOL	PARAMETER	LIM	ITS	UNIT
SYMBOL	PARAMETER	MIN	MAX	UNII
V _{CC}	DC supply voltage	4.5	5.5	V
V _{IH}	High-level input voltage	2.0	_	V
V_{IL}	Low-level Input voltage	_	0.8	V
T _{amb}	Operating free-air temperature range	-40	+85	°C

NOTE:

DC ELECTRICAL CHARACTERISTICS

					LIMITS		
SYMBOL	PARAMETER		TEST CONDITIONS	T _{amb}	UNIT		
				MIN	TYP ¹	MAX	
V _{IK}	Input clamp voltage		V _{CC} = 4.5 V; I _I = -18 mA	_	_	-1.2	V
V _P	Pass voltage		$V_I = V_{CC} = 5.0 \text{ V}; I/O = -100 \text{ mA}$	3.4	3.6	3.9	V
IĮ	Input leakage current		V _{CC} = 5.5 V; V _I = GND or 5.5 V	_	_	±1	μΑ
Icc	Quiescent supply current		$V_{CC} = 5.5 \text{ V}; I_{O} = 0, V_{I} = V_{CC} \text{ or GND}$	_	_	3	μΑ
ΔI_{CC}	Additional supply current per	nput pin ²	V_{CC} = 5.5 V, one input at 3.4 V, other inputs at V_{CC} or GND	_	_	2.5	mA
C _I	Control pins		V _I = 3 V or 0	_	3.3	_	pF
0	Dower off lookens ourrent	A port	$V_O = 3 \text{ V or } 0; \overline{OE} = V_{CC}$	_	9.9	_	pF
$C_{IO(OFF)}$	Power-off leakage current	B port	$V_O = 3 \text{ V or } 0; \overline{OE} = V_{CC}$	_	6.4	_	pF
			$V_{CC} = 4.5 \text{ V}; V_I = 0 \text{V}; I_I = 64 \text{ mA}$	_	5	7	Ω
r_{on}^3	On-resistance		$V_{CC} = 4.5 \text{ V}; V_I = 0 \text{V}; I_I = 30 \text{ mA}$	_	5	7	Ω
			V _{CC} = 4.5 V; V _I = 2.4 V; I _I = 15 mA	_	10	15	Ω

NOTES:

- 1. All typical values are at V_{CC} = 5 V, T_{amb} = 25 °C.
- 2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND
- Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

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CBT3257

AC CHARACTERISTICS

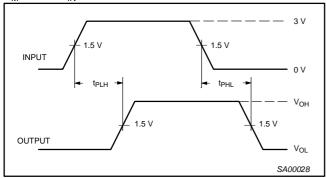
 $T_{amb} = -40 \text{ to } +85 \text{ }^{\circ}\text{C}; C_L = 50 \text{ pF}$

				LIM	ITS	
SYMBOL	PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = +5.0	UNIT	
			(0011 01)	MIN	MAX	
t _{pd}	Propagation delay ¹	A or B	B or A		0.25	ns
t _{pd}	Propagation delay	S	Α	1.6	5.0	ns
	Output enable time	ŌĒ	A or B	1.8	5.1	ns
t _{en}	to High and Low level	S	В	1.6	5.2	ns
	Output disable time	ŌĒ	A or B	2.2	5.5	ns
t _{dis}	from High and Low level	S	В	1.0	5.0	ns

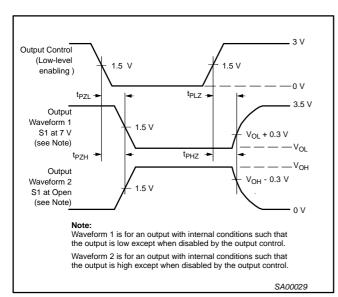
NOTE:

AC WAVEFORMS

 $V_{M} = 1.5 \text{ V}, V_{IN} = \text{GND to } 3.0 \text{ V}$



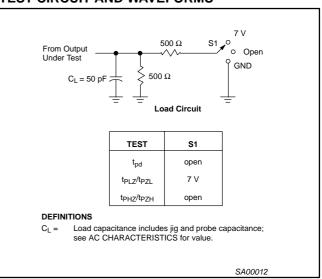
Waveform 1. Input to Output Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times NOTES:

- 1. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- 2. t_{PZL} and t_{PZH} are the same as t_{en}.
- 3. t_{PLH} and t_{PHL} are the same as t_{pd} .

TEST CIRCUIT AND WAVEFORMS



NOTES:

- 1. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 $\Omega,\,t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- The outputs are measured one at a time with one transition per measurement.

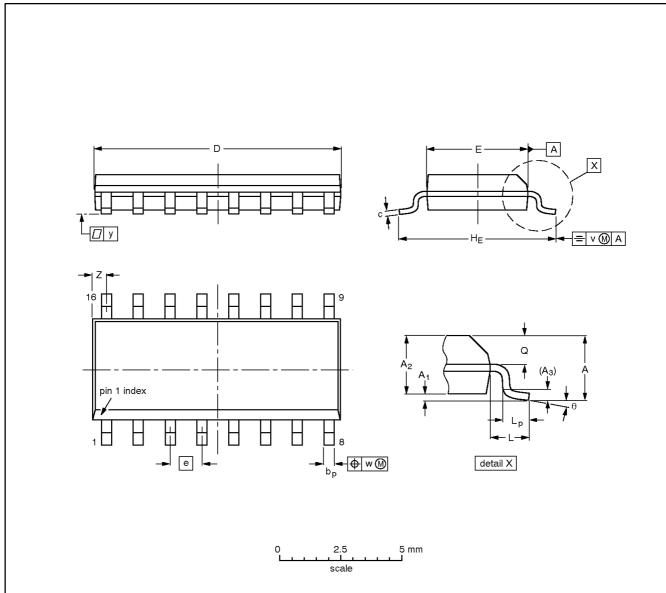
^{1.} The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

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CBT3257

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bр	c	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ö	>	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	o°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

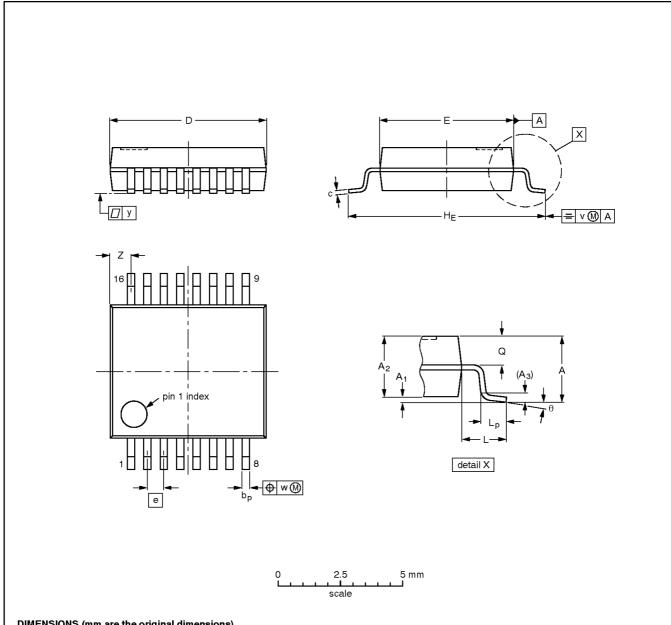
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT109-1	076E07	MS-012				97-05-22 99-12-27

Quad 1-of-2 multiplexer/demultiplexer

CBT3257

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	O	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	ø	>	×	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

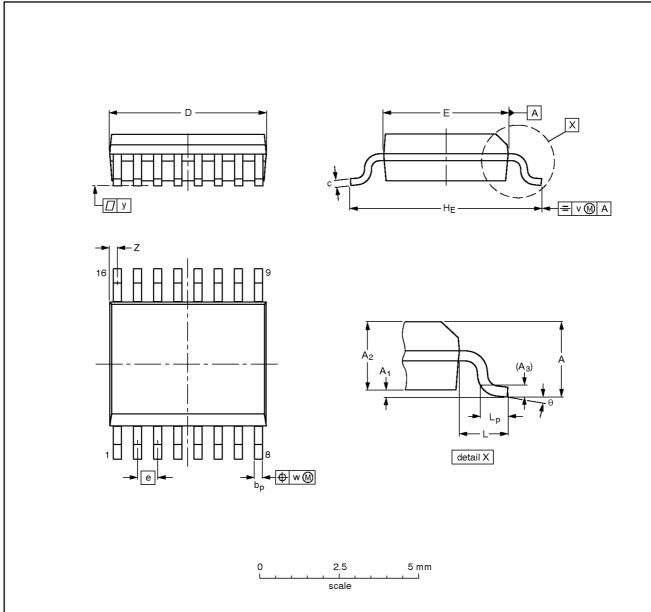
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT338-1		MO-150				-95-02-04- 99-12-27

Quad 1-of-2 multiplexer/demultiplexer

CBT3257

SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm

SOT519-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	v	w	у	Z ⁽¹⁾	θ
mm	1.73	0.25 0.10	1.55 1.40	0.25	0.31 0.20	0.25 0.18	5.0 4.8	4.0 3.8	0.635	6.2 5.8	1.0	0.89 0.41	0.2	0.18	0.09	0.18 0.05	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

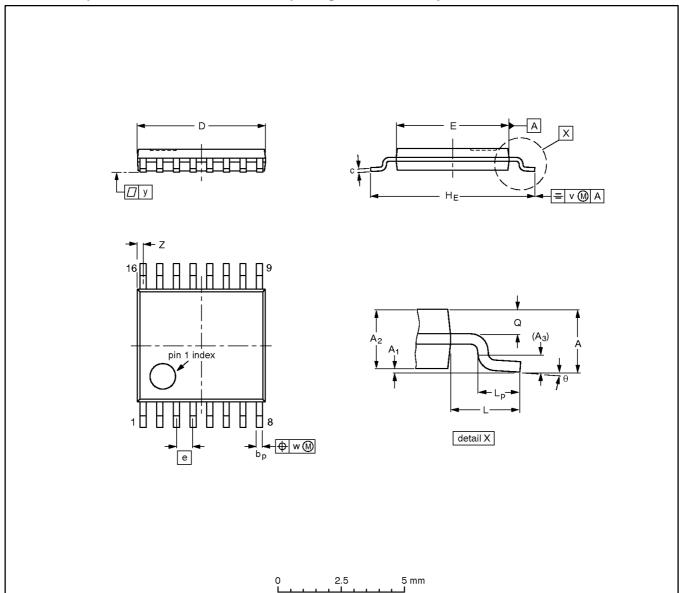
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT519-1						99-05-04	

Quad 1-of-2 multiplexer/demultiplexer

CBT3257

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

scale

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				-95-04-04 99-12-27	

Quad 1-of-2 multiplexer/demultiplexer

CBT3257

REVISION HISTORY

Rev	Date	Description
_2	20021213	Product data (9397 750 10869); ECN 853-2381 29158 of 06 November 2002.
		Modifications:
		Corrections to Block Diagram graphic.
_1	20020927	Product data (9397 750 10332); ECN 853-2381 28892 of 27 September 2002.

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CBT3257

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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^[1] Please consult the most recently issued data sheet before initiating or completing a design.

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